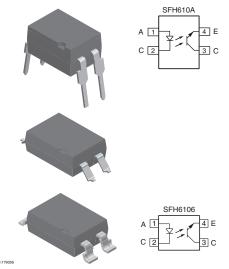


Vishay Semiconductors

Optocoupler, Phototransistor Output, High Reliability, 5300 V_{RMS}



DESCRIPTION

The SFH610A (DIP) and SFH6106 (SMD) feature a high current transfer ratio, low coupling capacitance and high isolation voltage. These couplers have a GaAs infrared diode emitter, which is optically coupled to a silicon planar phototransistor detector, and is incorporated in a plastic DIP-4 or SMD package.

The coupling devices are designed for signal transmission between two electrically separated circuits.

The couplers are end-stackable with 2.54 mm spacing.

Creepage and clearance distances of > 8.0 mm are achieved with option 6. This version complies with IEC 60950 (DIN VDE 0805) for reinforced insulation up to an operation voltage of 400 $V_{\rm RMS}$ or DC. Specifications subject to change.

FEATURES

- Good CTR linearity depending on forward current
- Isolation test voltage, 5300 V_{RMS}
- High collector emitter voltage, $V_{CEO} = 70 \text{ V}$
- Low saturation voltage
- · Fast switching times
- Low CTR degradation
- Temperature stable
- Low coupling capacitance
- End stackable, 0.100" (2.54 mm) spacing
- High common mode interference immunity
- Lead (Pb)-free component
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- DIN EN 60747-5-5 (VDE 0884) available with option 1
- CSA 93751
- BSI IEC 60950; IEC 60065

ORDERING INFORMATION					
PART	REMARKS				
SFH610A-1	CTR 40 % to 80 %, DIP-4				
SFH610A-2	CTR 63 % to 125 %, DIP-4				
SFH610A-3	CTR 100 % to 200 %, DIP-4				
SFH610A-4	CTR 160 % to 320 %, DIP-4				
SFH610A-5	CTR 250 % to 500 %, DIP-4				
SFH6106-1	CTR 40 % to 80 %, SMD-4				
SFH6106-2	CTR 63 % to 125 %, SMD-4				
SFH6106-3	CTR 100 % to 200 %, SMD-4				
SFH6106-4	CTR 160 % to 320 %, SMD-4				
SFH6106-5T	CTR 250 % to 500 %, SMD-4, tape and reel				
SFH610A-1X006	CTR 40 % to 80 %, DIP-4 400 mil				
SFH610A-1X018T	CTR 40 % to 80 %, SMD-4 400 mil, wide leadspread				
SFH610A-2X006	CTR 63 % to 125 %, DIP-4 400 mil				
SFH610A-3X006	CTR 100 % to 200 %, DIP-4 400 mil				
SFH610A-3X007	CTR 100 % to 200 %, SMD-4				
SFH610A-4X006	CTR 160 % to 320 %, DIP-4 400 mil				

Note

• For additional information on the available options refer to option information.

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1 For technical questions, contact: <u>optocoupleranswers@vishav.com</u>

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Pb-free





SFH610A, SFH6106

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ABSOLUTE MAXIMUM RAT	TINGS (T _{amb} = 25 °C, unless oth	herwise specifie	ed)	
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V _R	6	V
DC forward current		I _F	60	mA
Surge forward current	t ≤ 10 µs	I _{FSM}	2.5	А
Power dissipation		P _{diss}	100	mW
OUTPUT			· ·	
Collector emitter voltage		V _{CE}	70	V
Emitter collector voltage		V _{EC}	7	V
Collector current		Ι _C	50	mA
Collector current	t _p ≤ 1.0 ms	Ι _C	100	mA
Power dissipation		P _{diss}	150	mW
COUPLER			· ·	
Isolation test voltage between emitter and detector		V _{ISO}	5300	V _{RMS}
Creepage distance			≥7	mm
Clearance distance			≥7	mm
Insulation thickness between emitter and detector			≥ 0.4	mm
Comparative tracking index per DIN IEC112/VDE 0303 part 1			≥ 175	
	V _{IO} = 500 V, T _{amb} = 25 °C	R _{IO}	≥ 10 ¹²	Ω
Isolation resistance	V _{IO} = 500 V, T _{amb} = 100 °C	R _{IO}	≥ 10 ¹¹	Ω
Storage temperature range		T _{stg}	- 55 to + 150	°C
Ambient temperature range		T _{amb}	- 55 to + 100	°C
Soldering temperature ⁽¹⁾	$\begin{array}{c} \mbox{max. 10 s, dip soldering distance} \\ \mbox{to seating plane} \geq 1.5 \mbox{ mm} \end{array}$	T _{sld}	260	°C

Notes

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.

⁽¹⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
INPUT		• •			•	•	•	
Forward voltage	I _F = 60 mA		VF		1.25	1.65	V	
Reverse current	V _R = 6 V		I _R		0.01	10	μA	
Capacitance	$V_R = 0 V$, f = 1 MHz		Co		13		pF	
Thermal resistance			R _{thja}		750		K/W	
OUTPUT		•						
Collector emitter capacitance	$V_{CE} = 5 V$, f = 1 MHz		C _{CE}		5.2		pF	
Thermal resistance			R _{thja}		500		K/W	
		SFH610A-1	I _{CEO}		2	50	nA	
		SFH6106-1	I _{CEO}		2	50	nA	
		SFH610A-2	I _{CEO}		2	50	nA	
		SFH6106-2	I _{CEO}		2	50	nA	
	101/	SFH610A-3	I _{CEO}		5	100	nA	
Collector emitter leakage current	V _{CE} = 10 V	SFH6106-3	I _{CEO}		5	100	nA	
		SFH610A-4	I _{CEO}		5	100	nA	
		SFH6106-4	I _{CEO}		5	100	nA	
		SFH610A-5	I _{CEO}		5	100	nA	
		SFH6106-5T	I _{CEO}		5	100	nA	

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ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
COUPLER								
Collector emitter saturation voltage	$I_{\rm F}$ = 10 mA, $I_{\rm C}$ = 2.5 mA		V _{CEsat}		0.25	0.4	V	
Coupling capacitance	f = 1 MHz		C _C		0.4		pF	

Note

• Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
		SFH610A-1	CTR	40		80	%	
		SFH6106-1	CTR	40		80	%	
		SFH610A-2	CTR	63		125	%	
		SFH6106-2	CTR	63		125	%	
	$1 - 10 m \Lambda V = 5.0 V$	SFH610A-3	CTR	100		200	%	
	I _F = 10 mA, V _{CE} = 5.0 V	SFH6106-3	CTR	100		200	%	
		SFH610A-4	CTR	160		320	%	
		SFH6106-4	CTR	160		320	%	
1.4		SFH610A-5	CTR	250		500	%	
I _C /I _F		SFH6106-5T	CTR	250		500	%	
	I _F = 1 mA, V _{CE} = 5 V	SFH610A-1	CTR	13	30		%	
		SFH6106-1	CTR	13	30		%	
		SFH610A-2	CTR	22	45		%	
		SFH6106-2	CTR	22	45		%	
		SFH610A-3	CTR	34	70		%	
		SFH6106-3	CTR	34	70		%	
		SFH610A-4	CTR	56	90		%	
		SFH6106-4	CTR	56	90		%	

SWITCHING CHARACTERISTICS								
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT	
NON-SATURATED								
Current	V_{CC} = 5 V, R_L = 75 Ω		۱ _F		10		mA	
Rise time	V_{CC} = 5 V, R_L = 75 Ω		t _r		2		μs	
Fall time	V_{CC} = 5 V, R_L = 75 Ω		t _f		2		μs	
Turn-on time	V_{CC} = 5 V, R_L = 75 Ω		t _{on}		3		μs	
Turn-off time	V_{CC} = 5 V, R_L = 75 Ω		t _{off}		2.3		μs	
Cut-off frequency	$V_{CC} = 5 V$		F _{CO}		250		kHz	
SATURATED								
		SFH610A-1	1_	IF	20		mA	
		SFH6106-1	IF		20		ШA	
		SFH610A-2	1	IF	10		m۸	
Current		SFH6106-2	١F				mA	
Current		SFH610A-3	1		10		mA	
		SFH6106-3	I _F				IIIA	
		SFH610A-4	I _F		5		mA	
		SFH6106-4	١F				ШA	

3



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PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
SATURATED							
		SFH610A-1					
		SFH6106-1	t _r		2		μs
		SFH610A-2			_		
		SFH6106-2	t _r		3		μs
Rise time		SFH610A-3			0		_
		SFH6106-3	t _r		3		μs
		SFH610A-4			4		
		SFH6106-4	t _r		4		μs
		SFH610A-1	+		11		
		SFH6106-1	t _f		11		μs
		SFH610A-2	+.		14		110
Fall time		SFH6106-2	t _f				μs
Fail time		SFH610A-3	- t _f - t _f		14		μs
		SFH6106-3					μο
		SFH610A-4			15		μs
		SFH6106-4					μυ
		SFH610A-1	t _{on}		3		μs
		SFH6106-1	on				μο
		SFH610A-2	t _{on}		4.2		μs
Turn-on time		SFH6106-2	-011				μ0
		SFH610A-3	t _{on}		4.2		μs
		SFH6106-3	-011	Son			P
		SFH610A-4	t _{on}	ton	6		μs
		SFH6106-4	011				
		SFH610A-1	t _{off}		18		μs
		SFH6106-1	0.1				
Turn-off time		SFH610A-2	t _{off}		23		μs
		SFH6106-2					· ·
		SFH610A-3	t _{off}		23		μs
		SFH6106-3					· · · · ·
		SFH610A-4	t _{off}		25		μs
		SFH6106-4	5				

Note

• All values presented are typical values.

4



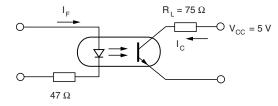
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SAFETY AND INSULATIO RATINGS								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Climatic classification (according to IEC 68 part 1)				55/100/21				
Comparative tracking index		CTI	175		399			
V _{IOTM}			10000			V		
V _{IORM}			890			V		
P _{SO}					400	mW		
I _{SI}					275	mA		
T _{SI}					175	°C		
Creepage distance	standard DIP-4		7			mm		
Clearance distance	standard DIP-4		7			mm		
Creepage distance	400 mil DIP-4		8			mm		
Clearance distance	400 mil DIP-4		8			mm		
Insulation thickness, reinforced rated	per IEC 60950 2.10.5.1		0.4			mm		

Note

• As per IEC 60747-5-2, § 7.4.3.8.1, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

TYPICAL CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)



isfh610a_01

Fig. 1 - Linear Operation (without saturation)

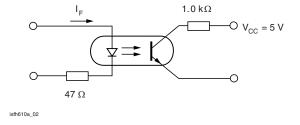


Fig. 3 - Switching Operation (with saturation)

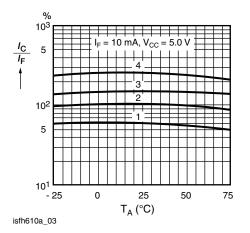
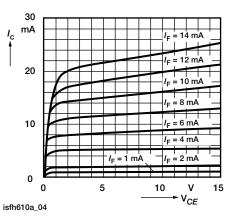


Fig. 2 - Current Transfer Ratio (CTR) vs. Temperature







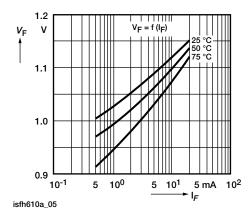


Fig. 5 - Diode Forward Voltage vs. Forward Current

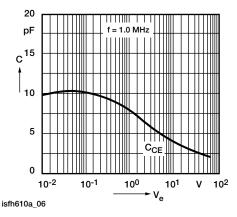


Fig. 6 - Transistor Capacitance (typ.) vs. Collector Emitter Voltage

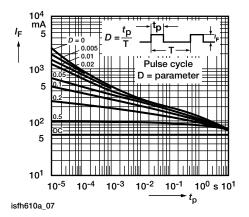
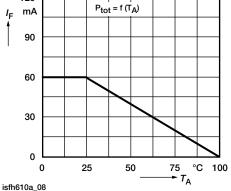


Fig. 7 - Permissible Pulse Handling Capability Forward Current vs. Pulse Width

60

120



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Fig. 8 - Permissible Power Dissipation vs. Temperature

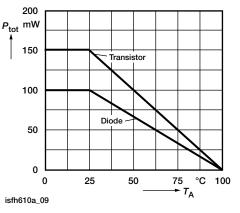
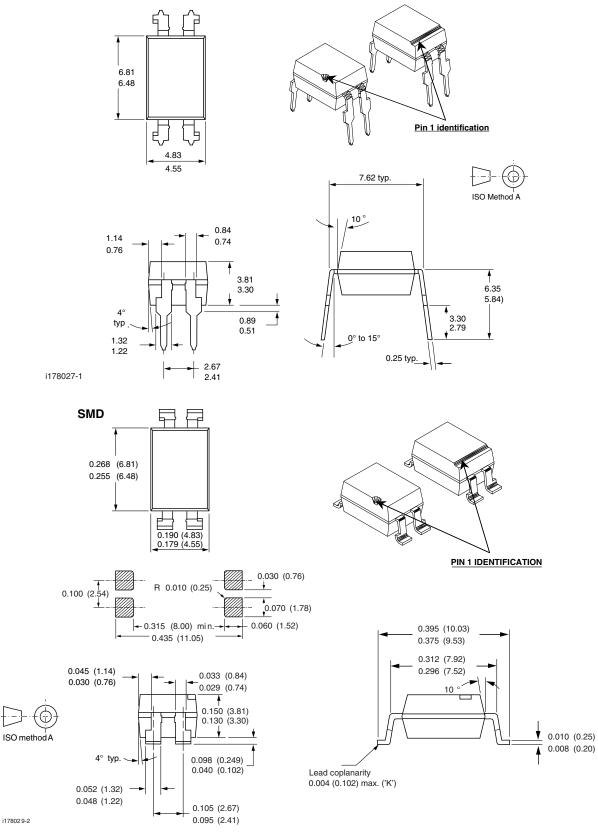


Fig. 9 - Permissible Diode Forward Current vs. Ambient Temperature



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PACKAGE DIMENSIONS in inches (millimeters)



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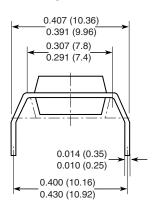
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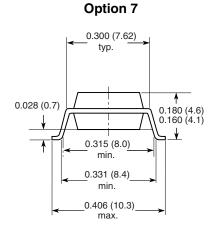
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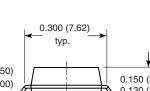


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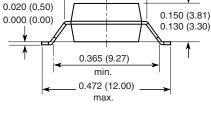
Option 6







Option 8



18487



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